PIC1205HP SERIES

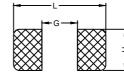
1. PART NO. EXPRESSION :



2. CONFIGURATION & DIMENSIONS :

4R7 1150

- (a) Series code
- (b) Dimension code
- (c) Type code
- (d) Inductance code : 4R7 = 4.70uH
- (e) Tolerance code : M = $\pm 20\%$, Y = $\pm 30\%$
- (f) F : RoHS Compliant
- (g) 11~99 : Internal controlled number



Recommended PC Board Pattern

I Init m/m

						Unit.m/m	
А	В	С	D	Е	G	Н	L
13.5±0.5	12.5±0.3	4.8±0.2	2.3±0.3	4.7±0.3	8.0	5.0	14.2

3. SCHEMATIC :



4. MATERIALS :



- (a) Core(b) Wire(c) Terminal
- (d) Ink
- (e) Paint

5. GENERAL SPECIFICATION :

- a) Test Freq. : L : 100KHz/1.0V
- b) Operating Temp. : -40°C to +125°C
- c) Storage Temp. : -40°C to +125°C
- d) Humidity Range : 85 \pm 3% RH
- e) Heat Rated Current (Irms) will cause the coil temperature rise approximately ∆t of 40°C (keep 1min)
- f) Saturation Current (Isat) will cause L0 to drop 20%.
- g) Part Temperature (Ambient+Temp. Rise) : Should not exceed 125°C under worst case operating conditions.
- h) Storage condition (component in its packaging)
 - i) Temperature: -10 to 40°C
 - ii) Humidity: 50~60% RH

NOTE : Specifications subject to change without notice. Please check our website for latest information.



06.11.2015

PIC1205HP SERIES

6. ELECTRICAL CHARACTERISTICS :

Part No.	Inductance L0 (µH) @ 0 A	Irms (A) Typ.	lsat (A) Typ.	DCR (mΩ) Typ. @ 25°C	DCR (mΩ) Max. @ 25°C
PIC1205HPR20MF	0.20	52	110	0.45	0.55
PIC1205HPR22MF	0.22	52	110	0.5	0.7
PIC1205HPR33MF	0.33	42	80	0.7	0.9
PIC1205HPR36MF	0.36	42	75	0.75	0.95
PIC1205HPR39MF	0.39	42	70	0.78	0.95
PIC1205HPR47MF	0.47	38	65	0.86	1.1
PIC1205HPR50MF	0.50	37	60	0.9	1.3
PIC1205HPR56MF	0.56	36	55	1.0	1.5
PIC1205HPR68MF	0.68	34	54	1.4	1.7
PIC1205HPR82MF	0.82	31	52	1.7	2.1
PIC1205HP1R0MF	1.00	29	50	1.85	2.5
PIC1205HP1R2MF	1.20	28	49	2.5	3
PIC1205HP1R5MF	1.50	27	48	2.8	3.3
PIC1205HP1R8MF	1.80	21	40	4.0	4.9
PIC1205HP2R2MF	2.20	20	32	4.2	5.5
PIC1205HP3R3MF	3.30	15	32	6.8	9.2
PIC1205HP4R7MF	4.70	12	27	11.4	15.0
PIC1205HP5R6MF	5.60	11.5	22	12.3	16.5
PIC1205HP6R0MF	6.00	11.5	21.5	13	16.5
PIC1205HP6R8MF	6.80	11	21	14.5	18.5
PIC1205HP8R2MF	8.20	9.5	18	16.8	22.5
PIC1205HP100MF	10.0	9.0	16	21.4	25.5
PIC1205HP150MF	15.0	8.2	13	32	38
PIC1205HP180MF	18.0	7.5	11	40	45
PIC1205HP220MF	22.0	6.5	10	50	58

Tolerance code : M = $\pm 20\%$, Y = $\pm 30\%$

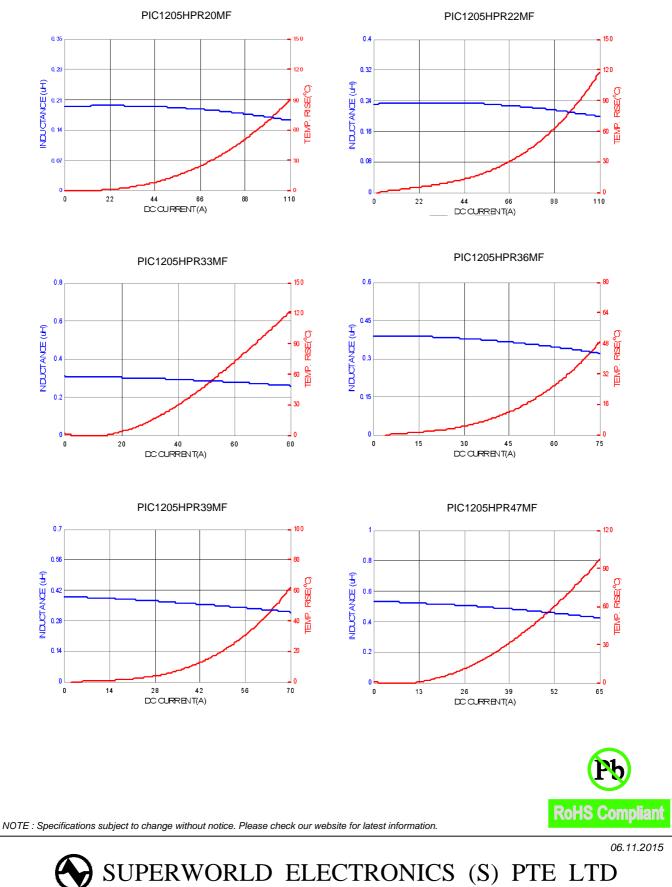


NOTE : Specifications subject to change without notice. Please check our website for latest information.

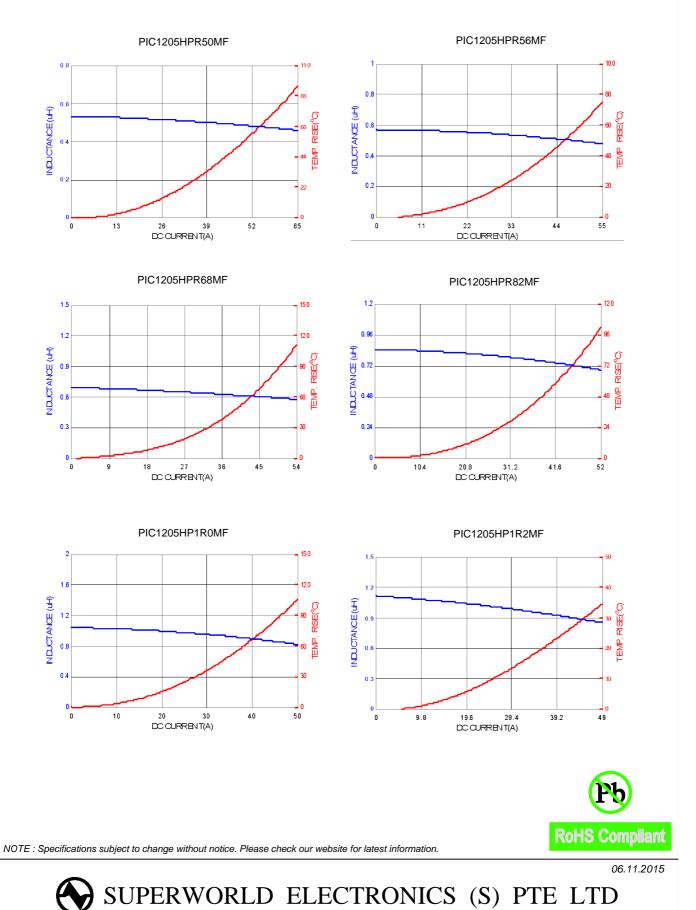
06.11.2015

PIC1205HP SERIES

7. CHARACTERISTICS CURVES :

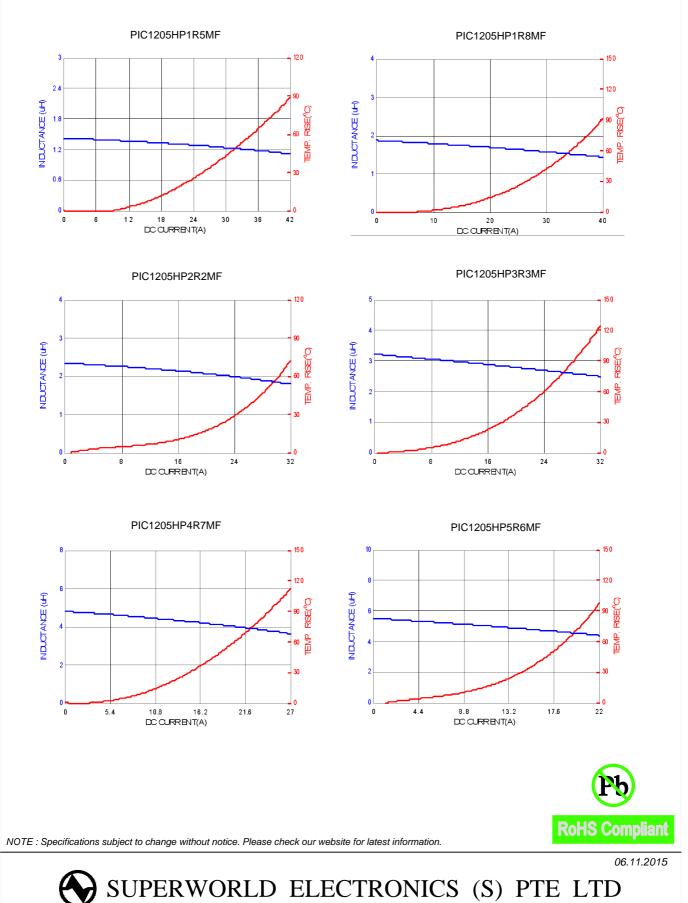


PIC1205HP SERIES



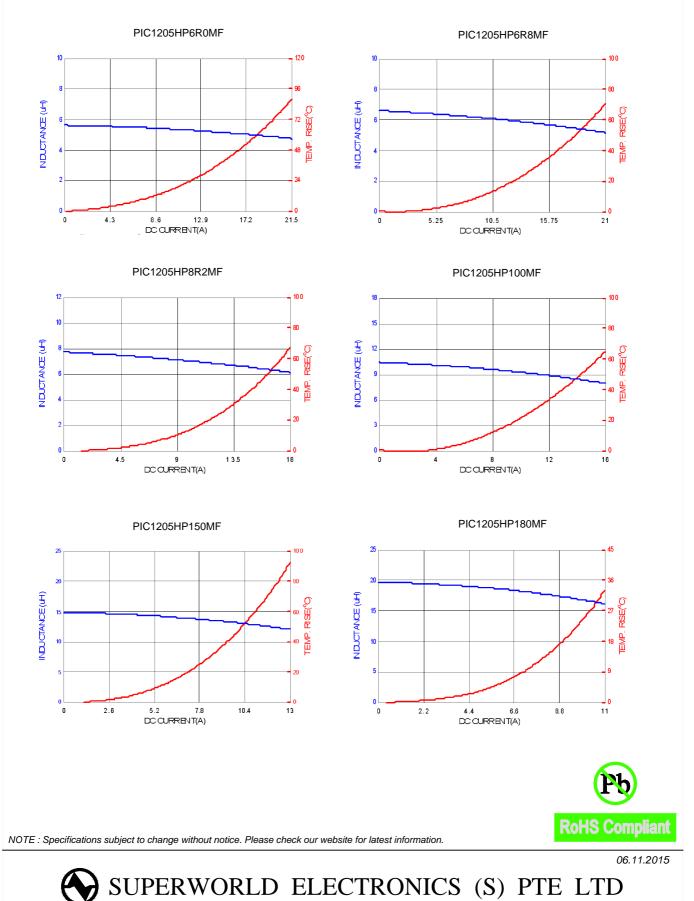
PG. 4

PIC1205HP SERIES



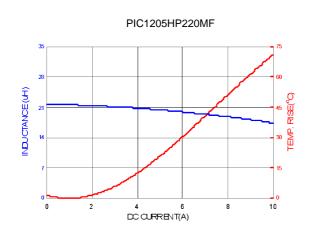
PG. 5

PIC1205HP SERIES



PG.6

PIC1205HP Series





NOTE : Specifications subject to change without notice. Please check our website for latest information.

06.11.2015



PIC1205HP SERIES

8. SOLDERING

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-1.1 Solder Re-flow :

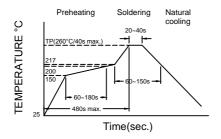
Recommended temperature profiles for re-flow soldering in Figure 1.

8-1.2 Soldering Iron (Figure 2) :

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. Note :

a) Preheat circuit and products to 150°C.

- b) 355°C tip temperature (max)
- c) Never contact the ceramic with the iron tip
- d) 1.0mm tip diameter (max)
- e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- f) Limit soldering time to 4~5 secs.





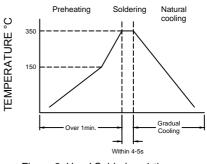


Figure 2. Hand Soldering: 1 times max.



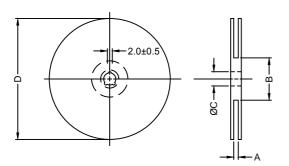
NOTE : Specifications subject to change without notice. Please check our website for latest information.

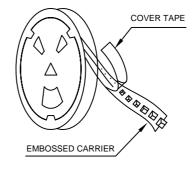
06.11.2015

PIC1205HP SERIES

9. PACKAGING INFORMATION :

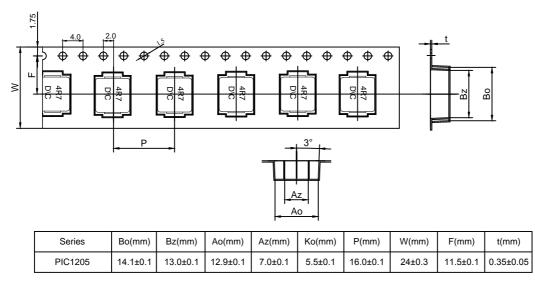
9-1. Reel Dimension





Туре	A(mm)	B(mm)	C(mm)	D(mm)
13" x 24mm	24.4+2.0/-0	100±2	13.5±0.5	330

9-2. Tape Dimension



9-3. Packaging Quantity

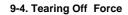
Size	PIC1205		
Chip / Reel	500		
Inner Box	1000		
Carton	4000		

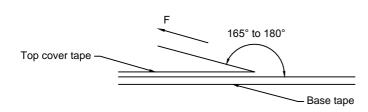


NOTE : Specifications subject to change without notice. Please check our website for latest information.

06.11.2015

PIC1205HP Series





The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions. (referenced ANSI/EIA-481-C-2003 of 4.11 standard)

Room Temp.	Room Humidity	Room atm	Tearing Speed
(°C)	(%)	(hPa)	(mm/min)
5~35	45~85	860~1060	

Application Notice

- 1. Storage Conditions :
 - To maintain the solderabililty of terminal electrodes :
 - a) Recommended products should be used within 12 months from the time of delivery.
 - b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation :

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) Vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.



NOTE : Specifications subject to change without notice. Please check our website for latest information.

06.11.2015